

CELCON®

Celcon® acetal copolymer grade M90 is a medium viscosity polymer providing optimum performance in injection molding and extrusion of thin walled tubing and thin gauge film. This grade provides overall excellent performance in many applications. Chemical abbreviation according to ISO 1043-1: POM Please also see Hostaform® C 9021.

Product information

1 Todact information			
Resin Identification	POM		ISO 1043
Part Marking Code	>POM<		ISO 11469
Rheological properties			
Melt volume-flow rate	8	cm ³ /10min	ISO 1133
Temperature	374		
Load	4.76	lb	
Melt mass-flow rate	9	g/10min	ISO 1133
Melt mass-flow rate, Temperature	374	°F	
Melt mass-flow rate, Load	4.76	lb	
Molding shrinkage, parallel	2.0	%	ISO 294-4, 2577
Molding shrinkage, normal	1.9	%	ISO 294-4, 2577
Typical mechanical properties			
Tensile modulus	400000	psi	ISO 527-1/-2
Tensile stress at yield, 50mm/min	9400	psi	ISO 527-1/-2
Tensile strain at yield, 50mm/min	10	%	ISO 527-1/-2
Flexural modulus	370000	psi	ISO 178
Flexural stress at 3.5%	10600	psi	ISO 178
Compressive stress at 1% strain	4500	•	ISO 604
Tensile creep modulus, 1h	355000	•	ISO 899-1
Tensile creep modulus, 1000h	196000	•	ISO 899-1
Charpy impact strength, 23°C		ftlb/in ²	ISO 179/1eU
Charpy impact strength, -30°C		ftlb/in ²	ISO 179/1eU
Charpy notched impact strength, 23°C		ftlb/in²	ISO 179/1eA
Charpy notched impact strength, -30°C		ftlb/in ²	ISO 179/1eA
Izod notched impact strength, 23°C		ftlb/in ²	ISO 180/1A
Izod notched impact strength, -30°C		ftlb/in²	ISO 180/1A
Izod impact strength, 23°C		ftlb/in²	ISO 180/1U
Izod impact strength, -30°C		ftlb/in ²	ISO 180/1U
Poisson's ratio	0.4		
Thermal properties			
Melting temperature, 10°C/min	331	°F	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	214	°F	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	316	°F	ISO 75-1/-2
Ball pressure test	302		IEC 60695-10-2
Coefficient of linear thermal expansion	0.67	E-4/°F	ISO 11359-1/-2
(CLTE), parallel			
Coefficient of linear thermal expansion (CLTE),	0.667	E-4/°F	ISO 11359-1/-2
normal			
Thermal conductivity of melt		W/(m K)	ISO 22007-2
Effective thermal diffusivity, flow	4.85E-8	m²/s	ISO 22007-4

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Specific heat capacity of melt 2210 J/(kg K) ISO 22007-4

Flammability

Burning Behav. at 1.5mm nom. thickn.	НВ	class	IEC 60695-11-10
Thickness tested	0.0591	in	IEC 60695-11-10
UL recognition	yes		UL 94
Oxygen index	14.9	%	ISO 4589-1/-2
FMVSS Class	В		ISO 3795 (FMVSS 302)
Burning rate, Thickness 1 mm	1.42	in/min	ISO 3795 (FMVSS 302)

Electrical properties

Volume resistivity	8E12 Ohm.m	IEC 62631-3-1
Surface resistivity	3E16 Ohm	IEC 62631-3-2
Arc Resistance	240 s	UL 746B

Physical/Other properties

Humidity absorption, 2mm	0.2 %	Sim. to ISO 62
Water absorption, 2mm	0.75 %	Sim. to ISO 62
Density	0.0509 lb/in ³	ISO 1183

Injection

Drying Recommended	no
Drying Temperature	212 °F
Drying Time, Dehumidified Dryer	3-4 h
Processing Moisture Content	≤0.2 %
Melt Temperature Optimum	365 °F
Min. melt temperature	356 °F
Max. melt temperature	374 °F
Screw tangential speed	≤0.3 m/s
Mold Temperature Optimum	212 °F
Min. mold temperature	176 °F
Max. mold temperature	248 °F
Hold pressure range	8700 - 17400 psi
Back pressure	4 psi
Ejection temperature	266 °F

Characteristics

Processing Injection Molding, Film Extrusion, Extrusion, Sheet Extrusion, Other Extrusion, Blow

Molding, Calendering, Compression molding

Delivery form Pellets

Additional information

Injection molding Preprocessing

Drying is generally not required because Celcon® and Hostaform® acetal copolymers are not hydroscopic nor are they degraded by moisture during processing. Excessive moisture can lead to splay (silver streaking) in molded

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parts. For better uniformity in molding especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying conditions are 80 C (180 F) for 3hours. Desiccant hopper dryers are not required. Maximum water content = 0.35%

Processing

Standard reciprocating screw injection molding machines with a high compression screw (minimum 3:1 and preferably 4:1) and low back pressure (0.35 Mpa/50 PSI) are favored. Using a low compression screw (I.E. general purpose 2:1 compression ratio) can result in unmelted particles and poor melt homogeneity. Using a high back pressure to make up for a low compression ratio may lead to excessive shear heating and deterioration of the material.

Melt Temperature: Preferred range 182-199 C (360-390 F). Melt temperature should never exceed 230 C (450 F).

Mold Surface Temperature: Preferred range 82-93 C (180-200 F) especially with wall thickness less than 1.5 mm (0.060 in.). May require mold temperature as high as 120 C (250 F) to reproduce mold surface or to assure minimal molded in stress. Wall thickness greater than 3mm (1/8 in.) may use a cooler (65 C/150 F) mold surface temperature and wall thickness over 6mm (1/4 in.) may use a cold mold surface down to 25 C (80 F). In general, mold surface temperatures lower than 82 C (180 F) may hinder weld line formation and produce a hazy surface or a surface with flow lines, pits and other included defects that can hinder part performance.

Postprocessing

Postprocessing conditioning and moisturizing are not required. It may be necessary to fixture large or complicated parts with varying wall thickness to prevent warpage while cooling to ambient temperature.

Preprocessing

Drying is generally not required because Celcon materials are not hydroscopic nor are they degraded by moisture during processing. Excessive moisture can cause surface defects on the extruded film. For better uniformity especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying conditions are 3 Hrs. at 80 C (180 F). Desiccant hopper dryers are not required. Max. moisture content = 0.35%.

Processing

Standard extruders with a length to diameter ratio of at least 20:1 are recommended. The screw should be a high compression ratio of at least 3:1 and preferably 4:1 to assure good melting and melt homogeneity. The design should be approximately 35% each for feed and metering sections with the remaining

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30% as the transition zone.

Source: Celanese Materials Database

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Film extrusion



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Melt temperature: 160-220 C (320-430 F)

Postprocessing

Postprocessing conditioning or moisturizing is not required.

Other extrusion

Preprocessing

Drying is generally not required because Celcon materials are not hydroscopic nor are they degraded by moisture during processing. Excessive moisture can cause surface defects. For better uniformity especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying is 3 hours at 80 C (180 F). Desiccant hopper dryers are not required. Max. moisture content = 0.35%

Processing

Standard extruders with a length to diameter ratio of at least 20:1 are recommended. The screw should be a high compression ratio of at least 3:1 and preferably 4:1 to assure good melting and uniform melt homogeneity. The design should be approximately 35% each for the feed and metering sections with the remaining 30% as transition zone.

Melt temperature 180-220 C (355-430F)

Postprocessing

Postprocessing conditioning or moisturizing are not required. For thick walled sections (>3mm or 1/8 in.), annealing is recommended to reduce internal stresses.

Annealing temperature: 130-140 C (265-285 F)

Annealing time: 10 min/mm thickness

Profile extrusion

Preprocessing

Drying is generally not required because Celcon materials are not hydroscopic nor are they degraded by moisture during processing. Excessive moisture can cause surface defects on the extrusion. For better uniformity especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying conditions are 3 Hrs. at 80 C (180 F). Desiccant hopper dryers are not required. Max. moisture content = 0.035%.

Processing

Standard extruders with a length to diameter ratio of at least 20:1 are recommended. The screw should be a high compression ratio of at least 3:1 and preferably 4:1 to assure good melting and melt homogeneity. The design should

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be approximately 35% each for feed and metering sections with the remaining 30% as the transition zone.

Melt temperature: 180-220 C (360-430 F).

Postprocessing

Postprocessing or moisturizing is not required. For thick walled extrusions (>3 mm or 1/8 in.), annealing is recommended to reduce internal stresses.

Annealing temperature: 130-140 C (265-285 F)

Annealing time: 10 min/mm thickness

Sheet extrusion

Preprocessing

Drying is generally not required because Celcon materials are not hydroscopic nor are they degraded by moisture during processing. Excessive moisture can lead to surface defects. For better uniformity in sheet extrusion especially when using regrind or material that has been stored in containers open to the atmosphere, recommended drying is 3 hours at 80 C (180 F). Desiccant hopper dryers are not required. Max. water content = 0.35%.

Processing

Standard extruders with a length to diameter ratio of at least 20:1 are recommended. The screw should be a high compression ratio (at least 3:1 and preferably 4:1) to assure good melting and uniform melt homogeneity. The screw design should be approximately 35% each for the feed and metering sections with the remaining 30% as the transition zone.

Melt temperature 180-190 C (355-375 F).

Postprocessing

Postprocessing conditioning or moisturizing is not required. For thick walled sections (>3mm or 1/8 in.), annealing is recommended to reduce internal stresses.

Annealing temperature: 130-140 C (265-285 F)

Annealing time: 10 min/mm wall thickness

Blow molding Preprocessing

Consult product information services.

Processing

Consult product information services.

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Postprocessing

Consult product information services.

Calandering Preprocessing

Consult product information services.

Processing

Consult product information services.

Postprocessing

Consult product information services.

Compression molding Preprocessing

Consult product information services.

Processing

Consult product information services.

Postprocessing

Consult product information services.

Processing Notes Pre-Drying

Drying is not normally required. If material has come in contact with moisture through improper storage or handling or through regrind use, drying may be

necessary to prevent splay and odor problems.

Automotive

OEM STANDARD ADDITIONAL INFORMATION
BAIC Q-BJEV 01.59

Bosch N28 BN22-O034 Natural, Made in Suzano
Bosch N28 BN22-O034 Black, Made in Suzano
Bosch N28 BN22-O034 Natural, Made In Bishop
Bosch N28 BN22-O034 Black, Made In Bishop

CATL MCR0000416
Chery Q/SQR S1-19-2023

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 Continental
 30.5251-0367.7

 Continental
 TST N 055 54.07

Evergrande Auto EGW.PL.0603-POM-CO

Ford WSK-M4D635-A2 Natural & Black

General Motors Special Part Approval, Please See Your CE

Account Representative.

General Motors GMW22P-POM-C2 Black
General Motors GMW22P-POM-C2 Natural

Great Wall Motor MP05-01

Hyundai MS237-09 Type A

 Li Auto
 Q/LiA5310020
 2021 (V2)

 Mercedes-Benz
 DBL5405-06-POM-C
 CF2001 Natural

Nissan POM-IC2-1

Renault EP03-3, PMR2020, No Spec, Special Part

Approval, See Your CE Account Manager.

Renault EP03a, PMR2020, No Spec, Special Part

Approval, See Your CE Account Manager.

Renault IP13g, PMR2020, No Spec, Special Part

Approval, See Your CE Account Manager.

Renault PMR2020, UB15, No Spec, Special Part

Approval, See Your CE Account Manager.

Renault UB03f, PMR2020, No Spec, Special Part

Approval, See Your CE Account Manager.

Rivian RMS.2007 Natural and Black

SAIC Motor SMTC 5 310 020

 Stellantis - Chrysler
 MS.50095 / CPN-1532
 Natural

 Stellantis - Chrysler
 MS.50095 / CPN-1586
 Black

 Stellantis - Chrysler
 MS.50095 / CPN-3766
 Canod

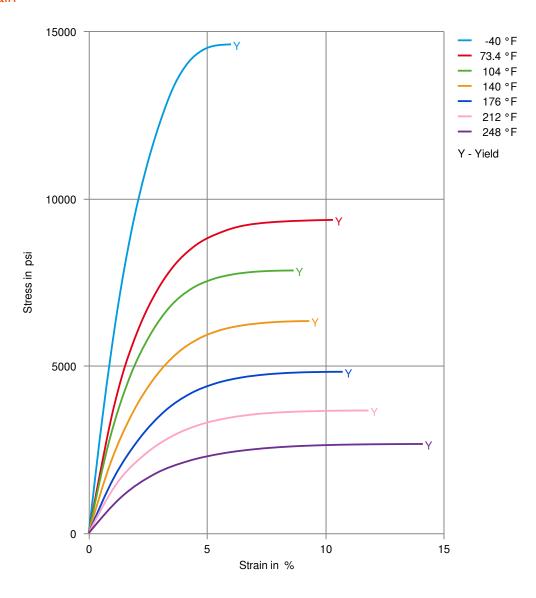
TeslaTM-1005-40Black, Bishop USATeslaTM-1005-50Black, Bishop USA

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Stress-strain

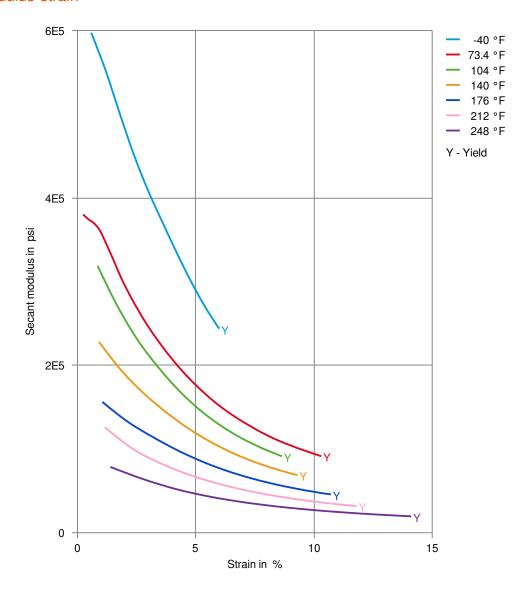


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Secant modulus-strain

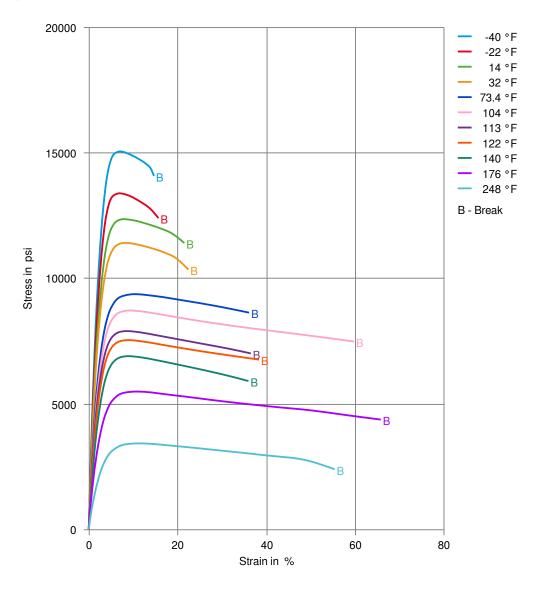


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Stress-strain, 50mm/min

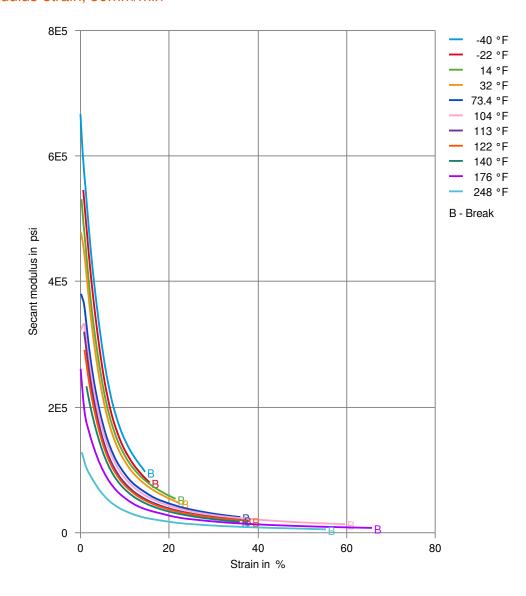


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CELCON®

Secant modulus-strain, 50mm/min

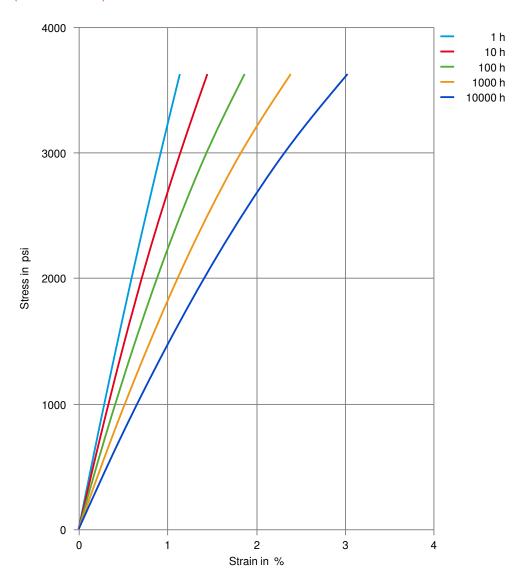


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Stress-strain (isochronous) 73.4°F

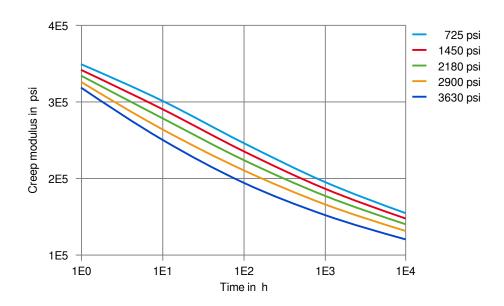


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Creep modulus-time 73.4°F

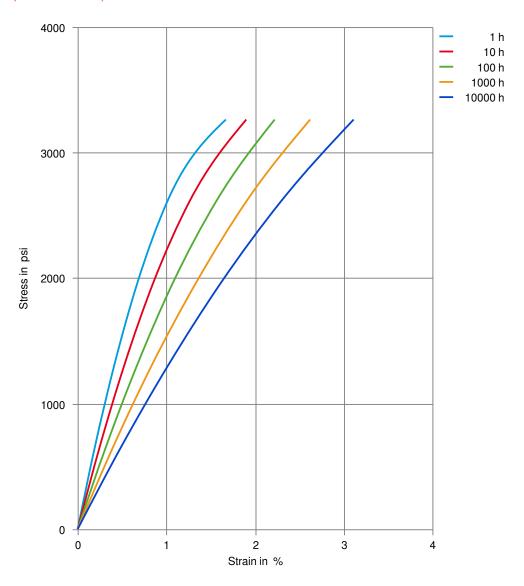


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Stress-strain (isochronous) 104°F

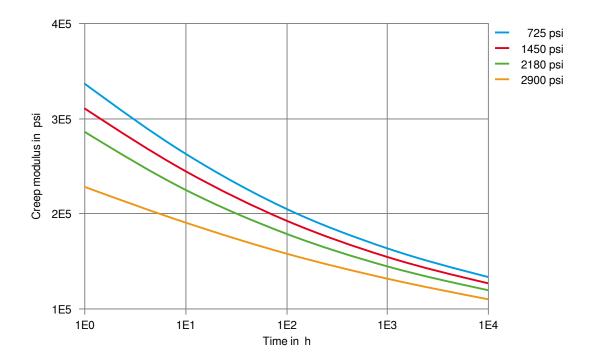


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Creep modulus-time 104°F



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NOTICE TO USERS: Values shown are based on testing of laboratory test specimens and represent data that fall within the standard range of properties for natural material. These values alone do not represent a sufficient basis for any part design and are not intended for use in establishing maximum, minimum, or ranges of values for specification purposes. Colorants or other additives may cause significant variations in data values. Properties of molded parts can be influenced by a wide variety of factors including, but not limited to, material selection, additives, part design, processing conditions and environmental exposure. Other than those products expressly identified as medical grade (including by MT® product designation or otherwise), Celanese's products are not intended for use in medical or dental implants. Regardless of any such product designation, any determination of the suitability of a particular material and part design for any use contemplated by the users and the manner of such use is the sole responsibility of the users, who must assure themselves that the material as subsequently processed meets the needs of their particular product or use. To the best of our knowledge, the information contained in this publication is accurate; however, we do not assume any liability whatsoever for the accuracy and completeness of such information. The information contained in this publication should not be construed as a promise or guarantee of specific properties of our products. It is the sole responsibility of the users to investigate whether any existing patents are infringed by the use of the materials mentioned in this publication. Moreover, there is a need to reduce human exposure to many materials to the lowest practical limits in view of possible adverse effects. To the extent that any hazards may have been mentioned in this publication, we neither suggest nor guarantee that such hazards are the only ones that exist. We recommend that persons intending to rely on any recommend that users seek and ad

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